

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









#### SE5012T: 5 GHz Front End Module with Power Detector

## **Applications**

- 5 GHz WLAN (IEEE802.11a/g/n)
- Access Points, PCMCIA, PC cards

#### **Features**

- 5GHz Front End Module with PA, LNA and T/R Switch
- Integrated power amplifier enable pin (VEN)
- Buffered, temperature compensated power detector
- High and Low-Linearity mode
- 5V or Direct-to-Battery operation
- 3% EVM, 64 QAM, 54 Mbps: 17dBm @3.3V or 21dBm @5V
- 30 dB Typical Gain
- Lead Free and RoHS compliant, halogen free package
- 16 pin 3 mm x 3 mm x 0.6 mm QFN, MSL1

## **Product Description**

The SE5012T is a 5GHz front end module offering high linear power for wireless LAN applications. It incorporates a power detector for control of the output power.

The SE5012T offers a high level of integration for a simplified design, providing quicker time to market and higher application board production yield. The device integrates the input match, inter-stage match, a temperature compensated, load insensitive power detector with 20dB of dynamic range, a 3.8GHz notch filter, a T/R switch and LNA.

For wireless LAN applications, the device meets the requirements of IEEE802.11a and delivers approximately 17dBm of linear output power at VCC=3.3V or 21dBm at VCC=5.0V. It also features a low linearity mode control to reduce current consumption at low power modes.

The SE5012T integrates the reference voltage generator, allowing for a true 1.8V CMOS compatible digital EN (enable) function to turn the power amplifier on and off.

# **Ordering Information**

Part Number	Package	Remark
SE5012T	16 Pin QFN	Samples
SE5012T-R	16 Pin QFN	Tape and Reel
SE5012T-EK1	Evaluation Kit	Standard

### **Functional Block Diagram**

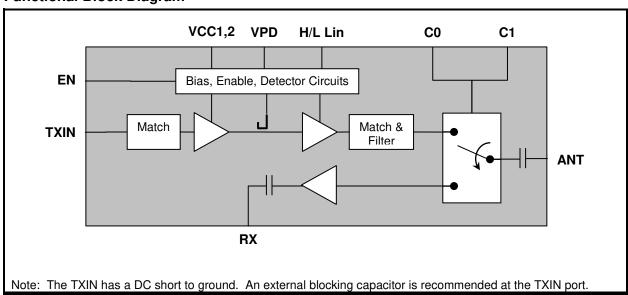


Figure 1: Functional Block Diagram



# SE5012T: 5 GHz Front End Module with Power Detector

# **Pin Out Diagram**

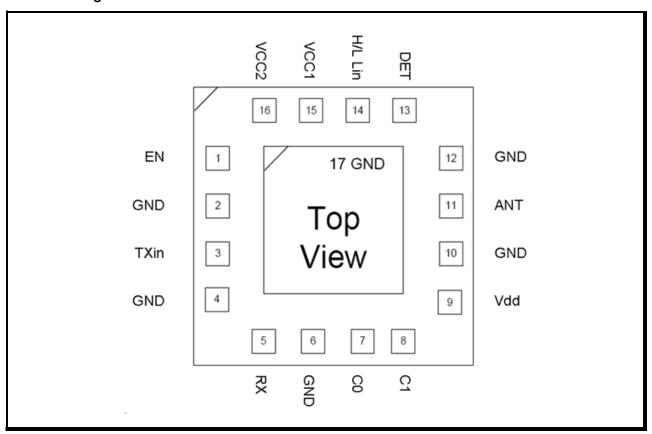


Figure 2: SE5012T Pin-Out Diagram

# **Pin Out Description**

Pin No.	Name	Description
1	EN	PA Enable
2	GND	Ground
3	TXIN	5GHz TX RF Input Signal
4	GND	Ground
5	RX	5GHz LNA Output Signal
6	GND	Ground
7	C0	Switch Control Logic 1
8	C1	Switch Control Logic 2

Pin No.	Name	Description
9	VDD	LNA Supply Voltage
10	GND	Ground
11	ANT	5GHz Antenna output
12	GND	Ground
13	DET	Power Detector Output
14	H/L Lin	High-Low linearity Control
15	VCC1	Power Amplifier Supply Voltage
16	VCC2	Power Stage Supply Voltage



SE5012T: 5 GHz Front End Module with Power Detector

# **Absolute Maximum Ratings**

These are stress ratings only. Exposure to stresses beyond these maximum ratings for a long period of time may cause permanent damage to, or affect the reliability of the device. Avoid operating the device outside the recommended operating conditions defined below. This device is ESD sensitive. Handling and assembly of this device should be at ESD protected workstations.

Symbol	Definition	Min.	Max.	Unit
Vcc	Supply Voltage on pins VCC1, VCC2	-0.3	5.5	V
VDD	Supply Voltage on pin VDD	-0.3	3.6	V
EN	DC input on Enable	-0.3	3.6	V
TXIN	RF Input Power, RFout into $50\Omega$ match	-	12	dBm
Тѕтс	Storage Temperature Range	-40	150	°C
ESD нвм	JEDEC JESD22-A114 all pins	-	500	V

# **Recommended Operating Conditions**

Symbol	Parameter	Min.	Max.	Unit
Vcc	Supply Voltage on pins VCC1, VCC2	3.0	5.5	V
VDD	Supply Voltage on pin VDD	3.0	3.6	V
TA	Ambient Temperature	-40	85	°C

# **Control Logic Characteristics**

Conditions: Vcc = 5.0 V; V<sub>DD</sub> = V<sub>EN</sub> = 3.3 V, T<sub>A</sub> = 25 °C, as measured on Skyworks Solutions' SE5012T-EV1 evaluation board, unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
		P <sub>OUT</sub> = 21 dBm, 54 Mbps, 64 QAM, VCC = 5.0V, H/L Lin = 3.3V (High Linearity)	-	270	-	
ICC- 802.11a	Supply Current, Transmit Mode	P <sub>OUT</sub> = 17 dBm, 54 Mbps, 64 QAM, VCC = 3.3V, H/L Lin = 3.3V (High Linearity)	-	195	-	mA
		P <sub>OUT</sub> = 13 dBm, 54 Mbps, 64 QAM, VCC = 3.3V, H/L Lin = 0V (Low Linearity)	-	165	-	
I <sub>DD</sub>	LNA Supply Current	VEN = C0 = 0V; C1 = 3.3V		13		
loff	Supply Current	V <sub>EN</sub> = 0 V, No RF, C0=C1=0 V Measured on VCC, VDD pins	-	20	50	μA
VENH	Logic High Voltage	-	2.8	-	3.6	V
VENL	Logic Low Voltage	-	-0.3	-	0.3	V
lenh	Input Current Logic High Voltage	10Kohm on chip pull down resistor	-	330	400	μΑ
IENL	Input Current Logic Low Voltage	-	-	<1	-	μΑ



# SE5012T: 5 GHz Front End Module with Power Detector

# **Switch Logic Characteristics**

Conditions:  $V_{CC} = 3.0 \text{ V}$  to 5.5 V,  $V_{DD} = V_{EN} = 3.3 \text{ V}$ ,  $T_A = 25 \,^{\circ}\text{C}$ , as measured on Skyworks Solutions' SE5012T-EK1 evaluation board, all unused ports terminated with 50 ohms, unless otherwise noted.

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
ON	Low Loss Switch Control Voltage	High State = Vctl_on - Vctl_off	2.8	-	3.6	V
OFF	High Loss Switch Control Voltage	Low State = Vctl_off - Vctl_off	0	-	0.3	V
Ссть	Control Input Capacitance	-	-	-	100	pF
I <sub>CTL</sub>	Control Line Current	Vctl = Vctl_on	-	2	10	uA

# **Switch Control Logic Table**

C0	C1	EN	Hi/L Lin	ANT	
ON	OFF	ON	OFF	TX Low Linearity	
ON	OFF	ON	ON	TX High Linearity	
OFF	OFF	OFF	D/C	Rx Bypass	
OFF	ON	OFF	D/C	Rx LNA ON	
ON	ON	Un-supported state			

Note: D/C = don't care



# SE5012T: 5 GHz Front End Module with Power Detector

# **AC Electrical Characteristics**

### Transmit Characteristics

Conditions:  $V_{CC} = 5.0V$ ,  $V_{DD} = V_{EN} = C0 = H/L$  Lin = 3.3V, C1 = 0V,  $T_{A} = 25$  °C, as measured on Skyworks Solutions' SE5012T-EV1 evaluation board, unless otherwise noted

Symbol	Parai	meter	Conditions	Min.	Тур.	Max.	Unit
fL-U	Frequency Ran	ge	-	5.15	-	5.85	GHz
		High Linearity	VCC = 5.0 V	-	21	-	
POUT	Output Power OFDM Signal,	Mode H/L Lin = 3.3V	VCC = 3.3 V	-	17	-	dBm
POUT	64QAM, EVM = 3%	Low Linearity	VCC = 5.0 V	-	17	-	QDIII
	= 076	Mode H/L Lin = 0V	VCC = 3.3 V	-	13	-	
P <sub>1dB</sub>	Output 1dB con	npression point,	VCC = 5.0V	-	27	-	dBm
FlaB	No Modulation		VCC = 3.3V	-	23	-	UDIII
S <sub>11</sub>	Input Return Lo	ss	PIN = -25 dBm	-	12	-	dB
S <sub>21</sub>	Small Signal Ga	ain,	5V, High or Low Linearity Mode	29	-	35	dB
<b>3</b> 21	$P_{IN} = -25dBm$		3.3V, High or Low Linearity Mode	28	-	33	
40			Gain variation over single 40MHz channel	-	-	0.5	10
ΔS21	Small Signal Ga	ain variation	Gain Variation over band	-	3.5	-	dB
S <sub>21_3.8</sub>	Out of Band Ga	in	Gain at 3.8GHz	-	-	15	dB
2f	11		D 47 -ID OFDM	-	-50	-45.2	-ID /NALI-
3f	Harmonic		Pout = 17 dBm, OFDM	-	-50	-45.2	dBm/MHz
tr, tf	Rise and Fall Ti	me	-	-	0.5	-	us
STAB	Stability		Pout = 17 dBm, 54 Mbps, 64 QAM, VSWR = 6:1, all phases	All non-h		ly related of dBc/100 kH	outputs less Hz
Rugged- ness	Tolerance to ou mismatching	tput load	Constant $P_{IN}$ equal to $P_{OUT} = 21$ dBm at 500hms, 54 Mbps, 64 QAM, VCC = 5.5V, VSWR = 6:1, all phases	No damage			
Robust	Robustness to i	nput power	P <sub>IN</sub> = 12dBm, CW, VSWR = 6:1, all phases		No c	lamage	



# SE5012T: 5 GHz Front End Module with Power Detector

### Receive Characteristics

Conditions:  $V_{CC} = 3.0 \text{ V}$  to 5.5 V,  $V_{DD} = C1 = 3.3 \text{V}$ ,  $V_{EN} = C0 = 0 \text{V}$ ,  $T_{A} = 25 \,^{\circ}\text{C}$ , as measured on Skyworks

Solutions' SE5012T-EK1 evaluation board, all unused ports terminated with 50 ohms, unless otherwise

noted.

Symbol	Parameter	Condition	Min.	Тур.	Max.	Unit
Fouт	Frequency Range	-	5.15	-	5.85	GHz
RX	Insertion Loss	Bypass Mode: C0 = C1 = 0V	-	-5	-	dB
ΠΛ	RX Gain	High Gain Mode	11	12	-	uБ
NF	Noise Figure	High Gain Mode	-	2.5	-	dB
	Input Return Loss	At the Antenna port	-	-11	-	
RXRL	Output Return Loss	At RX RF output	-	-8	dB -	
RxIP1DB	Input P1DB	Measured at ANT Port; High Gain Mode	-	-5	-	dBm
		LNA Bypass Mode	-	10	-	
Rx_2.4int	Max 2.4Ghz interferer power	1 dB degradation of IP1DB	-	-	0	dBm
TX <sub>LEAK</sub>	Transmit Power at RX Output	V <sub>EN</sub> = C0 = H/L Lin = 3.3V, C1 = 0V 24dBm at the ANT port	-	-13	-	dBm
T <sub>on/off</sub>	T/R on/off switching speed	C0, C1 (50%) to RF output (10% or 90%)	-	300	-	nSec



## SE5012T: 5 GHz Front End Module with Power Detector

### **Power Detector Characteristics**

Conditions: Vcc = 3.0 V to 5.5 V, Vdd = Ven = C0 = 3.3 V, C1 = 0 V, f = 5.4 GHz,  $Ta = 25 ^{\circ}\text{C}$ , as measured on

Skyworks Solutions' SE5012T-EV1 evaluation board, unless otherwise noted

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
PDR	Pout detect range	-	0	1	P <sub>1dB</sub>	dBm
VDET <sub>22</sub>	Detector voltage	Роит = 22 dВm	0.7	ı	0.9	V
VDET <sub>16</sub>	Detector voltage	Роит = <b>16 dBm</b>	0.50	-	0.60	V
VDET <sub>2</sub>	Detector voltage	Pout = 2 dBm	0.25	-	0.35	V
PDZout	Output Impedance	-	-	5	-	ΚΩ

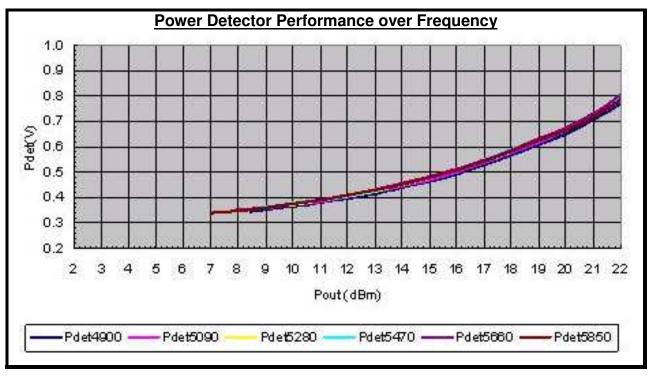


Figure 3: SE5012T Power Detector Characteristic



## SE5012T: 5 GHz Front End Module with Power Detector

# Package Diagram

This package is Pb free and RoHS compliant. The product is rated MSL1.

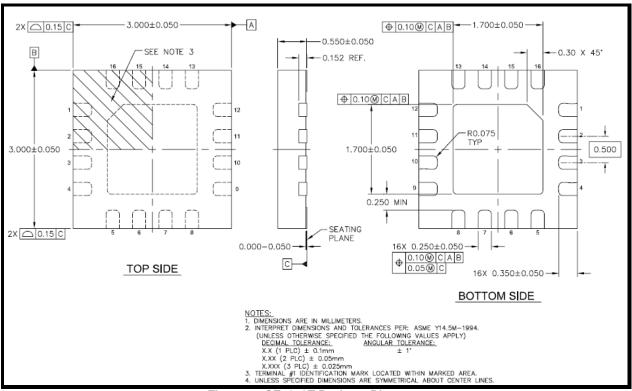


Figure 4: SE5012T Package Diagram



# DATA SHEET SE5012T: 5 GHz Front End Module with Power Detector

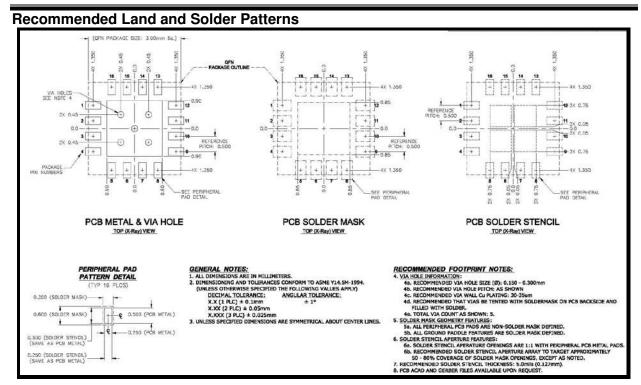
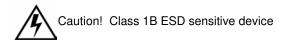


Figure 5: SE5012T Recommended Land and Solder Pattern

## **Package Handling Information**

Because of its sensitivity to moisture absorption, instructions on the shipping container label must be followed regarding exposure to moisture after the container seal is broken, otherwise, problems related to moisture absorption may occur when the part is subjected to high temperature during solder assembly. The SE5012T is capable of withstanding a Pb free solder reflow. Care must be taken when attaching this product, whether it is done manually or in a production solder reflow environment. If the part is manually attached, precaution should be taken to insure that the device is not subjected to temperatures above its rated peak temperature for an extended period of time. For details on both attachment techniques, precautions, and handling procedures recommended, please refer to:

- "Quad Flat No-Lead Module Solder Reflow & Rework Information", Document Number QAD-00045
- "Handling, Packing, Shipping and Use of Moisture Sensitive QFN", Document Number QAD-00044





SE5012T: 5 GHz Front End Module with Power Detector

# **Branding Information**

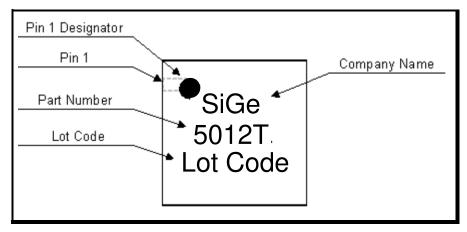


Figure 6: SE5012T Branding

# **Tape and Reel Information**

Parameter	Value
Devices Per Reel	3000
Reel Diameter	13 inches
Tape Width	12 millimeters

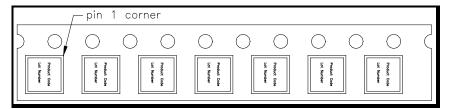


Figure 7: SE5012T-R Tape and Reel Information

# **Document Change History**

Revision	Date	Notes
1.0	Nov 05, 2010	Created
1.1	Nov 14, 2011	Updated package outline drawing Updated Max 2.5Ghz interferer power specification for LNA Add TX leakage at RX output port Update operating frequency Update TX gain slope
1.2	Jan 31, 2012	Updated current at 13dBm RX S11, S22
1.3	Apr 03, 2012	Updated with Skyworks logo and disclaimer statement
1.4	Jun 14, 2012	Updated LNA gain



# DATA SHEET SE5012T: 5 GHz Front End Module with Power Detector

Copyright © 2012 Skyworks Solutions, Inc. All Rights Reserved.

Information in this document is provided in connection with Skyworks Solutions, Inc. ("Skyworks") products or services. These materials, including the information contained herein, are provided by Skyworks as a service to its customers and may be used for informational purposes only by the customer. Skyworks assumes no responsibility for errors or omissions in these materials or the information contained herein. Skyworks may change its documentation, products, services, specifications or product descriptions at any time, without notice. Skyworks makes no commitment to update the materials or information and shall have no responsibility whatsoever for conflicts, incompatibilities, or other difficulties arising from any future changes.

No license, whether express, implied, by estoppel or otherwise, is granted to any intellectual property rights by this document. Skyworks assumes no liability for any materials, products or information provided hereunder, including the sale, distribution, reproduction or use of Skyworks products, information or materials, except as may be provided in Skyworks Terms and Conditions of Sale.

THE MATERIALS, PRODUCTS AND INFORMATION ARE PROVIDED "AS IS" WITHOUT WARRANTY OF ANY KIND, WHETHER EXPRESS, IMPLIED, STATUTORY, OR OTHERWISE, INCLUDING FITNESS FOR A PARTICULAR PURPOSE OR USE, MERCHANTABILITY, PERFORMANCE, QUALITY OR NON-INFRINGEMENT OF ANY INTELLECTUAL PROPERTY RIGHT; ALL SUCH WARRANTIES ARE HEREBY EXPRESSLY DISCLAIMED. SKYWORKS DOES NOT WARRANT THE ACCURACY OR COMPLETENESS OF THE INFORMATION, TEXT, GRAPHICS OR OTHER ITEMS CONTAINED WITHIN THESE MATERIALS. SKYWORKS SHALL NOT BE LIABLE FOR ANY DAMAGES, INCLUDING BUT NOT LIMITED TO ANY SPECIAL, INDIRECT, INCIDENTAL, STATUTORY, OR CONSEQUENTIAL DAMAGES, INCLUDING WITHOUT LIMITATION, LOST REVENUES OR LOST PROFITS THAT MAY RESULT FROM THE USE OF THE MATERIALS OR INFORMATION, WHETHER OR NOT THE RECIPIENT OF MATERIALS HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGE.

Skyworks products are not intended for use in medical, lifesaving or life-sustaining applications, or other equipment in which the failure of the Skyworks products could lead to personal injury, death, physical or environmental damage. Skyworks customers using or selling Skyworks products for use in such applications do so at their own risk and agree to fully indemnify Skyworks for any damages resulting from such improper use or sale.

Customers are responsible for their products and applications using Skyworks products, which may deviate from published specifications as a result of design defects, errors, or operation of products outside of published parameters or design specifications. Customers should include design and operating safeguards to minimize these and other risks. Skyworks assumes no liability for applications assistance, customer product design, or damage to any equipment resulting from the use of Skyworks products outside of stated published specifications or parameters.

Skyworks, the Skyworks symbol, and "Breakthrough Simplicity" are trademarks or registered trademarks of Skyworks Solutions, Inc., in the United States and other countries. Third-party brands and names are for identification purposes only, and are the property of their respective owners. Additional information, including relevant terms and conditions, posted at www.skyworksinc.com, are incorporated by reference.